

80V N-Channel Enhancement Mode MOSFET

Voltage	80 V	RDSON	5.5 mΩ
Current	108 A	Q _G (TYP)	65.8 nC

Feature:

- $R_{DS(ON)}$, $V_{GS}@10V$, $I_D@50A<5.5m\Omega$
- $R_{DS(ON)}$, $V_{GS}@7V$, $I_D@25A<7m\Omega$
- 100% Avalanche Tested
- 100% Rg Tested
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: TO-263 package

• Terminals: Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 1.38 grams

Application

• BMS, BLDC. SMPS SR.

TO-263 Cate Source

Absolute Maximum Ratings (T_A = 25 °C unless otherwise specified)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	V _{DS} 80		
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Proin Course of (Note 3)	Tc=25°C		108	Δ.	
Continuous Drain Current ^(Note 3)	Tc=100°C	I _D	68	Α	
Pulsed Drain Current	T _C =25°C	I _{DM}	360	Α	
Single Pulse Avalanche Current (Note 5)		I _{AS}	29.6	Α	
Single Pulse Avalanche Energy (Note 5)		E _{AS}	438	mJ	
Dawer Dissipation	Tc=25°C	Do	113.6	W	
Power Dissipation	T _C =100°C	— Po	45.5	VV	
Operating Junction and Storage Temperature	Range	T _J ,T _{STG}	-55~150	°C	

Thermal Characteristics

PARA	METER	SYMBOL	MAXIMUM	UNITS
	Junction-to-Case	$R_{ heta JC}$	1.1	°C/W
Thermal Resistance	Junction-to-Ambient (Note 4)	$R_{\theta JA}$	62.5	°C/W



Electrical Characteristics (T_A = 25 °C unless otherwise specified)

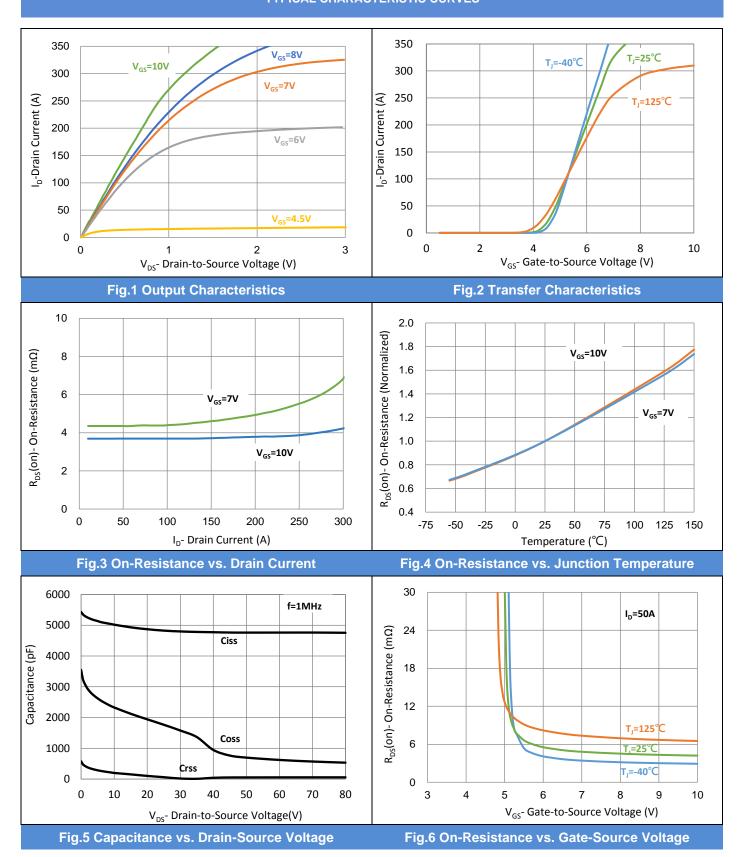
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS} (Note 7)	V _{GS} =0V, I _D =250uA	80	-	-	.,,
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2.25	3.1	3.75	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =50A	-	3.9	5.5	mΩ
(Note 1)		V _{GS} =7V, I _D =25A	-	4.5	7	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =80V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	$V_{GS}=\pm20V$, $V_{DS}=0V$	-	-	±100	nA
Dynamic (Note 6)						
		V _{DS} =40V, I _D =50A,		48	-	nC
Total Gate Charge	Qg	V _{GS} =7V	-			
			-	65.8	-	
Gate-Source Charge	Qgs	V _{DS} =40V, I _D =50A,	-	22.4	-	
Gate-Drain Charge	Qgd	V _{GS} =10V	-	12.9	-	
Input Capacitance	Ciss	10 10 1	-	4773	-	pF
Output Capacitance	Coss	V _{DS} =40V, V _{GS} =0V,	-	948	-	
Reverse Transfer Capacitance	Crss	F=1MHz	-	42	-	
Turn-On Delay Time	td(on)	101/ 1 504	-	44	-	
Turn-On Rise Time	t _r	V _{DD} =40V, I _D =50A,	-	108	-	
Turn-Off Delay Time	td _(off)	$V_{GS}=10V, R_{G}=2\Omega$ (Note 2)	-	73	-	ns
Turn-Off Fall Time	tf	(Note 2)	-	116	-	
Gate Resistance	Rg	f=1.0MHz	-	2.3	-	Ω
Drain-Source Diode						
Diode Forward Voltage	V _{SD}	I _S =50A, V _{GS} =0V	-	0.9	1.2	V
Reverse Recovery Charge	Qrr	I _S =50A	-	73.3	-	nC
Reverse Recovery Time	Trr	di/dt=100A/µs	-	56	-	ns

NOTES:

- 1. Pulse width<580us.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. The maximum current rating is silicon limited.
- 4. RθJA is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch2 with 2oz.square pad of copper.
- 5. The test condition is L=1mH, I_{AS}=29.6A, V_{DD} =40V, V_{GS} =10V, R_{G} =25ohm, Starting T_{J} =25°C
- 6. Guaranteed by design, not subject to production testing.
- 7. BVDSS is over 85V during mass production.



TYPICAL CHARACTERISTIC CURVES







TYPICAL CHARACTERISTIC CURVES

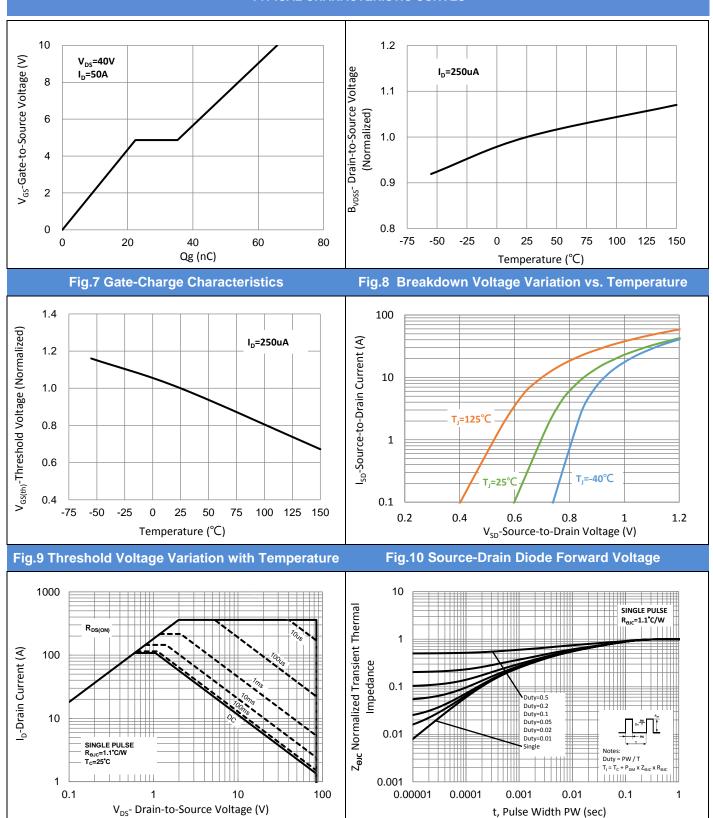


Fig.12 Normalized Transient Thermal Impedance

Fig.11 Maximum Safe Operating Area



TYPICAL CHARACTERISTIC CURVES

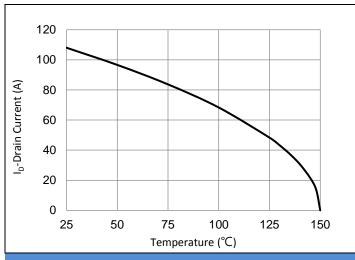


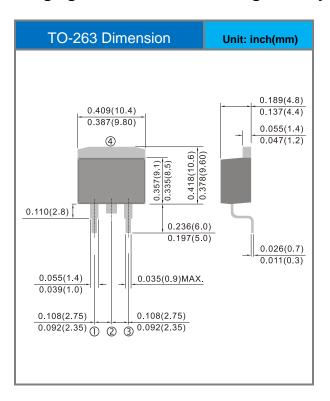
Fig.13 Drain Current vs. Case Temperature

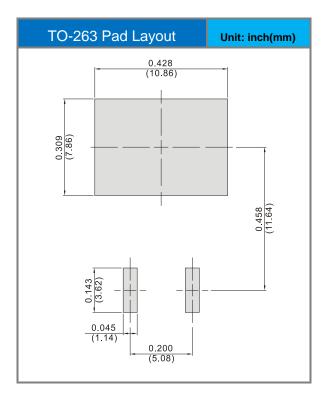


Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PSMB055N08NS1	TO-263	50pcs / Tube	055N08NS
F SIVIDUDUNCUOINS I	10-203	800pcs / Reel	UUUNUUUU

Packaging Information & Mounting Pad Layout





Marking Diagram

PJ 055N08NS YWLL x Y = Year Code

W = Week Code (A~Z)

LL = Lot Code (00~99)

x = Production Line Code





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